



SPECIFICATIONS

Rated Current:2.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°C to +105°C

Contact Material:Brass

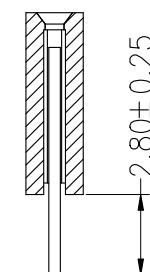
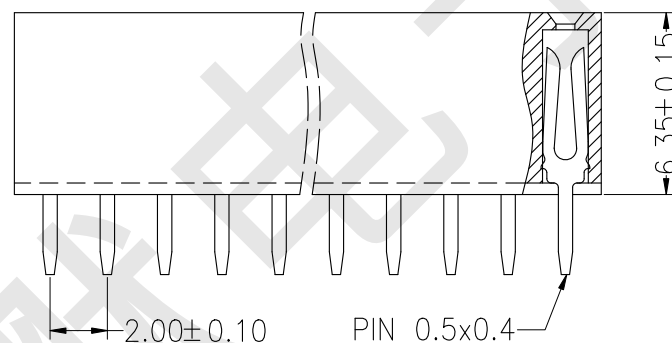
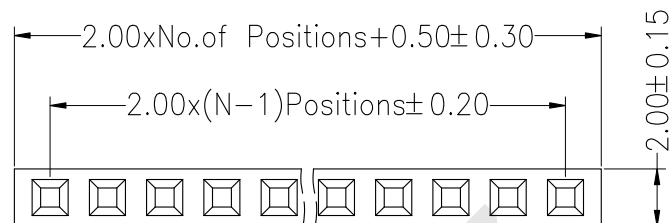
Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Resistance To Soldering Heat:

245°C±5°C, 10s(PBT insulator)

260°C±5°C, 10s(PA6T&PA9T&LCP insulator)



Ordering Information

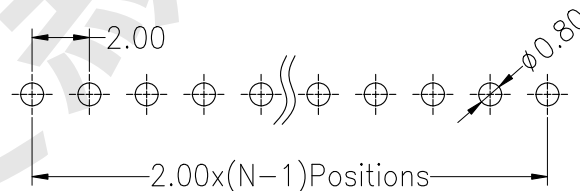
2363 01 XX X N XX S Y X 0X

No. of Pins
2-40

Insulator Material
Option
A=BK-PBT
C=BK-PA6T
E=BK-PA9T
F=BK-LCP

Contact Plating
G0:Gold Flash
G1:1u" Gold
G2:1.5u" Gold
G3:2u" Gold
G4:3u" Gold
G5:5u" Gold
G6:10u" Gold
G7:15u" Gold
G8:30u" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
O=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

				OPERATION		DRAW	ChenWei	21.11.04	SCALE	FIT	 上海爱默电子科技有限公司 TEL:86-21-37680290 FAX:86-21-37680291	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20	CHECK			SIZE	A4		
				X.XXX	±0.10				SHEET	1/1		
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	DIM	TOL	APPROVE		PROJ.		TITLE:	
1	2	3	4	5	6	7					PART NO.	
A0	2021.11.04	NEW DRAWING									236301XXXNXXSYX0X	
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	DIM	TOL					2.00PF H6.35mm 1xNpin 180°	